

8755 W. Higgins Road Suite 500 Chicago, Illinois USA 60631

July 29th, 2022

RE: PCN # ESU270-80 - SOT23-5L/6L additional backend location approval

To our valued customers,

Littelf use would like to notify you of an additional approved backend location for SOT23-5L/6L TVS Diode Array (SPA® Diodes) products. This additional backend factory in China is fully approved for all assembly, test, and packing operations. There are no changes to fit, form, and function of the finished products.

Qualification efforts are complete, and the new factory is ramping for shipments.

#### **Products Affected:**

Affected Part Numbers
SP0504BAHTG
SP3019-04HTG
SP0505BAHTG
SP0504SHTG
SP0504SHTG-ER

The affected products have been fully qualified in accordance with established performance and reliability criteria. The attached pages summarize the qualification results. Full qualification data and/or samples will be available upon request.

Form, fit, function changes: None Part number changes: None

Effective date: October 29th, 2022 or sooner

Replacement products: N/A

Last time buy: N/A

This notification is for your information and acknowledgement. If you have any other questions or concerns, please contact Sophia Hu, Assistant Product Manager.

We value your business and look forward to assisting you whenever possible.

Best Regards,

Sophia Hu TVS Diode Array Assistant Product Manager Semiconductor Business Unit, Wuxi, China +86 510 85277701 - 7653 shu@littelfuse.com

PCN#:	Contact Information			
ESU270-80 Date: July 29 <sup>th</sup> , 2022	Name: Sophia Hu			
	Title: Assistant Product Manager			
Product Identification:	Phone #: +86 13771377277			
SOT23-5L/6L additional backend location approval	Fax#: N/A			
Implementation Date for Change:	E-mail: shu@littelfuse.com			
Oct 29th, 2022 or sooner	E mair. Sha @macado.com			
Category of Change: Description of Cha	nge:			
ei iou en	backend assembly, test, and packing location for SOT23-			
Data Sheet 5L/6L. There are no	changes to fit, form & function of the finished products.			
☐ Technology				
☐ Discontinuance/Obsolescence				
☐ Equipment				
Manufacturing Site				
☑ Raw Material				
☐ Testing				
☐ Fabrication Process				
☐ Other:				
Important Dates:				
☑ Qualification Samples Available: Upon request	☐ Last Time Buy:			
☑ Final Qualification Data Available: Upon request				
☐ Date of Final Product Shipment:				
Method of Distinguishing Changed Product				
☐ Product Mark, See (8.0) in the succeeding PCN report for	details			
☐ Date Code,				
☐ Other,				
Demonstrated or Anticipated Impact on Form, Fit, Function or Reliability:				
N/A				
LF Qualification Plan/Results:				
Yes				
Customer Acknowledgement of Receipt: Littelfuse requests you	ou acknowledge receipt of this PCN. In your acknowledgement, you can			
grant approval or request additional information. Littelfuse will assume the change is acceptable if no acknowledgement is received within 30 days				
of this notice. Lack of any additional response within 90 days of PCN issuance further constitutes acceptance of the change.				



**Prepared By**: Jordan Hsieh-Product Engineering Manager,

Raider Chen-Product Engineer, Sophia Hu- Assistant Product Manager

**Date** : 2022/7/20

Device : SP3019-04HTG/SP0504SHTG/SP0504SHTG-ER/SP0504BAHTG/SP0505BAHTG

Revision : A

## 1.0 Objective:

This document is to qualify an additional assembly and testing site FOR SOT23-5L/6L package type. Summarize the physical, electrical and reliability test performed in qualification lots.

## 2.0 Applicable Devices:

#### 2.1 Product name:

Affected Part Numbers
SP0504BAHTG
SP3019-04HTG
SP0505BAHTG
SP0504SHTG
SP0504SHTG-ER

# 3.0 Assembly, Process & Material Differences/Changes:

### 3.1 Assembly Changes

No change of assembled process.

### 3.2 Process Changes

No change of process method.

3.3 Material Change

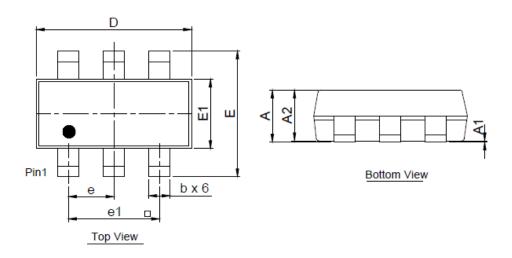
io material original						
SOT23-5/6L						
Item	Original	New	Change or not			
Lead frame	C194	C194	No			
Die Attach Material	84-1LMISR4	84-1LMISR4	No			
Wire	Gold	Gold	No			
Mold Compound	CEL8240HF10	EK3600	Yes			
Plating	MatteTin	MatteTin	No			

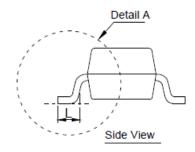
## 4.0 Packing Method:

SOT23-5/6L				
Item	Original	New	Change or not	
Color of 7-inch reel	Blue	Blue	No	
Innerbox	185*185*22(mm)	220*194*25(mm)	Yes	
Outerbox	350*220*230(mm) 650*260*260(mm) 610*450*210(mm)	438*231*241(mm)	Yes	

# 5.0 Physical Differences/Changes:

Symbol	Original		New			
Symbol	MIN	TYP	MAX	MIN	TYP	MAX
А			1.45			1.45
A1	0.000		0.15	0.000		0.15
A2	0.90	1.15	1.30	0.90		1.30
b	0.30		0.50	0.25		0.50
D	2.75	2.90	3.05	2.70		3.05
Е	2.60	2.80	3.00	2.60		3.00
E1	1.45	1.60	1.75	1.45		1.75
е	0.95 BSC		0.95 BSC			
e1	1.9 BSC		1.9 BSC			
L	0.30	0.50	0.60	0.30		0.55





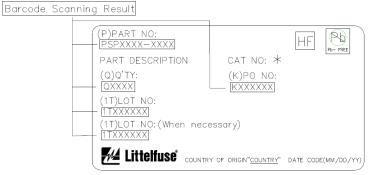
Test Items	Condition	S/S	Results	ETR#
Pre-conditioning (PC)	JESD22-A113	308 each lot	0/924	
DC Blocking (HTRB)	Bias = VRWM, Ta = 150°C, Duration = 1008 Hours	77 each lot		
Temperature Cycle (TC)	Ta = -55°C to +150°C, Duration = 1000 Cycles	77 each lot	0/231	
Temperature/Humidity (H3TRB)	Ta = 85°C, 85% RH, Bias = VRWM, Duration = 1008 Hours	77 each lot	0/231	175240 173926
Autoclave (AC)	Ta = 121°C, 100%RH, 2ATM, Duration = 96 Hours	77 each lot	0/231	173923
Resistance to Solder Heat (RSH)	260°C, 10 sec, M-2031	10 each lot	0/30	
Moisture Sensitivity Level (MSL)	Per Jedec J-STD-020D Level 1	308 each lot	0/924	
Solderability (SD)	ANSI-J-STD-002	10 each lot	0/30	

## 7.0 Electrical Characteristic Summary:

No change in electrical characteristics. Characterization data is available upon request.

## 8.0 Changed Part Identification:

Both were qualified suppliers and it can be identified by code of CAT NO on the label.



## 9.0 Approvals:

Sophia Hu SPA Assistant Product Manager Littelfuse, Wuxi <u>Jordan Hsieh</u> SPA Product Manager Littelfuse, HsinChu Raider Chen
SPA Product Engineer
Littelfuse, HsinChu